



XL-25 Series Ceramic Heat Spreader

Features

- · Best for limited space
- · Low thermal expansion coefficient
- · Reliable insulation performance
- · Low thermal expansion coefficient
- · Non-toxic, High temperature resistance
- · High reliability

Applications

Can adapt to dramatic environmental changes

Electronic components - Electric Vehicles, 5G, Autopilot System, Mobile Phone, AIOT, HPC (High Performance Computing), Server, IC, CPU, MOS, LED, Mother Board, Power Supply, Heat Sink, LCD-TV, Notebook, PC, Telecom Device, Wireless Hub, DDR II Module, etc.

Standard Sizes (mm)

 01. TO-220 20x14x0.635
 04. TO-247 22x17x0.635
 07. TO-264 28x22x1.0

 02. TO-220 20x14x1.0
 05. TO-247 22x17x1.0
 08. TO-3P 25x20x0.635

 03. TO-220 12x18.5x1.0
 06. TO-264 28x22x0.635
 09. TO-3P 25x20x1.0

Properties

Properties	XL-25W	XL-25D	Unit	Test Method
Thermal Conductivity	25	190~210	W/mK	-
Colour	White	Dark Grey	-	Visual
Dielectric Breakdown Voltage	15	18.45	KV/mm	ASTM D149
Bulk Density	≧ 3.8	3.32	g/cm³	CNS 619
Volume Resistance	10 ¹²	1.4×10 ¹³	Ohm-cm	-
Flexural Strength	4078.8	3416	kgf/cm²	CNS 12701
Linear Temperature Expansion Coefficient	6.6~8	2.805	10 ⁻⁶	RT~300° C
Main Composition	Al ₂ O ₃	AIN	-	-

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T-Global Technology are proud to announce the launch of a new company logo and mission statement as part of the ongoing growth and evolution of our company's brand.